

EMIFIL (Three-terminal capacitor) DSS1ZB3 □□□□□□□□□□
Murata Standard Reference Specification [AEC-Q200]

1. Scope

This reference specification applies to DSS1ZB3 series for Automotive Electronics based on AEC-Q200 except for Power train and Safety.

2. Part Numbering

(Ex.)

DS	S	1	Z	B3	2A	220	Q55	B
①	②	③	④	⑤	⑥	⑦	⑧	⑨

- ① Product ID (Disc-Type EMIFIL)
- ② Structure S : Built-in Ferrite Beads Type
- ③ Style
- ④ Features
- ⑤ Temperature Characteristics B3:±10% (-40~+85°C at 20°C)
- ⑥ Rated Voltage 2A :2A→100VDC、1H→50VDC
- ⑦ Capacitance

□	□	□
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↓
Marked three digits system.(Ex. 22pF→220、22000pF→223)

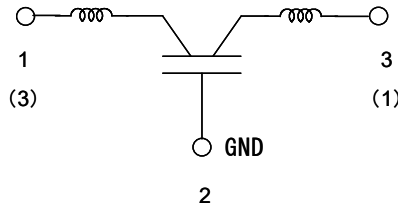
- ⑧ Lead Type
Q55 : Bulk
Lead Type :Straight Lead
Lead Length(l) 25.0 mm min. ※See item 10.

Q9□ : Taping
Lead Type :Straight Lead
Dimension H: Q91 : 20.0±1.0 mm
Q92 : 16.5±1.0 mm
Q93 : 18.5±1.0 mm ※See item 10.

- ⑨ Packaging Code A : Ammo Pack / B : Bulk

3. Rating

Operating temperature : -40 to +85°C
 Storage Temperature : -40 to +85°C
 Insulation Resistance : 1000MΩ min.
 Rated Current : 6A(DC)
 ESD Rank 2 : 2KV
 Equivalent Circuit :



Others : See Table 1

Table 1

Customer Part Number	Murata Part Number	Capacitance	Temperature Characteristics	Rated Voltage	Withstanding Voltage	Unit Mass (Typical value)
	DSS1ZB32A220Q55B	22 pF ± 10%	± 10%	100VDC	250VDC	0.45g
	DSS1ZB32A220Q91A					
	DSS1ZB32A220Q92A					
	DSS1ZB32A220Q93A					
	DSS1ZB32A330Q55B	33 pF ± 10%				
	DSS1ZB32A330Q91A					
	DSS1ZB32A330Q92A					
	DSS1ZB32A330Q93A					
	DSS1ZB32A470Q55B	47 pF ± 10%				
	DSS1ZB32A470Q91A					
	DSS1ZB32A470Q92A					
	DSS1ZB32A470Q93A					
	DSS1ZB32A680Q55B	68 pF ± 10%				
	DSS1ZB32A680Q91A					
	DSS1ZB32A680Q92A					
	DSS1ZB32A680Q93A					

Reference Only


Customer Part Number	Murata Part Number	Capacitance	Temperature Characteristics	Rated Voltage	Withstanding Voltage	Unit Mass (Typical value)
	DSS1ZB32A101Q55B	100 pF ± 10%	± 10%	100VDC	250VDC	0.45g
	DSS1ZB32A101Q91A					
	DSS1ZB32A101Q92A					
	DSS1ZB32A101Q93A					
	DSS1ZB32A121Q55B	120 pF ± 10%				
	DSS1ZB32A121Q91A					
	DSS1ZB32A121Q92A					
	DSS1ZB32A121Q93A					
	DSS1ZB32A151Q55B	150 pF ± 10%				
	DSS1ZB32A151Q91A					
	DSS1ZB32A151Q92A					
	DSS1ZB32A151Q93A					
	DSS1ZB32A221Q55B	220 pF ± 10%				
	DSS1ZB32A221Q91A					
	DSS1ZB32A221Q92A					
	DSS1ZB32A221Q93A					
	DSS1ZB32A271Q55B	270 pF ± 10%				
	DSS1ZB32A271Q91A					
	DSS1ZB32A271Q92A					
	DSS1ZB32A271Q93A					
	DSS1ZB32A331Q55B	330 pF ± 10%				
	DSS1ZB32A331Q91A					
	DSS1ZB32A331Q92A					
	DSS1ZB32A331Q93A					
	DSS1ZB32A471Q55B	470 pF ± 10%				
	DSS1ZB32A471Q91A					
	DSS1ZB32A471Q92A					
	DSS1ZB32A471Q93A					
	DSS1ZB32A681Q55B	680 pF ± 10%				
	DSS1ZB32A681Q91A					
	DSS1ZB32A681Q92A					
	DSS1ZB32A681Q93A					
	DSS1ZB32A102Q55B	1000 pF ± 10%				
	DSS1ZB32A102Q91A					
	DSS1ZB32A102Q92A					
	DSS1ZB32A102Q93A					
	DSS1ZB32A152Q55B	1500 pF ± 10%				
	DSS1ZB32A152Q91A					
	DSS1ZB32A152Q92A					
	DSS1ZB32A152Q93A					
	DSS1ZB32A222Q55B	2200 pF ± 10%				
	DSS1ZB32A222Q91A					
	DSS1ZB32A222Q92A					
	DSS1ZB32A222Q93A					
	DSS1ZB32A332Q55B	3300 pF ± 10%				
	DSS1ZB32A332Q91A					
	DSS1ZB32A332Q92A					
	DSS1ZB32A332Q93A					
	DSS1ZB32A472Q55B	4700 pF ± 10%				
	DSS1ZB32A472Q91A					
	DSS1ZB32A472Q92A					
	DSS1ZB32A472Q93A					

Customer Part Number	Murata Part Number	Capacitance	Temperature Characteristics	Rated Voltage	Withstanding Voltage	Unit Mass (Typical value)
	DSS1ZB32A682Q55B	6800 pF ± 10%	± 10%	100VDC	250VDC	0.45g
	DSS1ZB32A682Q91A					
	DSS1ZB32A682Q92A					
	DSS1ZB32A682Q93A					
	DSS1ZB32A103Q55B	10000 pF ± 10%				
	DSS1ZB32A103Q91A					
	DSS1ZB32A103Q92A					
	DSS1ZB32A103Q93A					
	DSS1ZB32A153Q55B	15000 pF ± 10%				
	DSS1ZB32A153Q91A					
	DSS1ZB32A153Q92A					
	DSS1ZB32A153Q93A					
	DSS1ZB32A223Q55B	22000 pF ± 10%				
	DSS1ZB32A223Q91A					
	DSS1ZB32A223Q92A					
	DSS1ZB32A223Q93A					
	DSS1ZB31H333Q55B	33000 pF ± 10%	50VDC	125VDC		
	DSS1ZB31H333Q91A					
	DSS1ZB31H333Q92A					
	DSS1ZB31H333Q93A					
	DSS1ZB31H473Q55B	47000 pF ± 10%				
	DSS1ZB31H473Q91A					
	DSS1ZB31H473Q92A					
	DSS1ZB31H473Q93A					
	DSS1ZB31H104Q55B	100000pF ± 10%				
	DSS1ZB31H104Q91A					
	DSS1ZB31H104Q92A					
	DSS1ZB31H104Q93A					

4. Style and Dimension

See item 9.

5. Marking

Trade Mark : Marked as 
 Capacitance : Marked three digits system. (Ex.221)
 Rated Voltage : Marked voltage value.(100V)

6. Testing Conditions

<Unless otherwise specified>

Temperature : Ordinary Temperature 15 to 35°C
 Humidity : Ordinary Humidity 25 to 85 %(RH)

<In case of doubt>

Perform a heat treatment at 150+0/-10°C for one hour and then set at room temperature for 24±2 hours.
 Temperature : 20 ± 2°C
 Humidity : 60 to 70 %(RH)
 Atmospheric Pressure : 86 to 106 kPa

7. Performance

No.	Item	Specification	Test Method												
7.1	Appearance and Dimensions	Meet item 10.	Visual Inspection and measured with Slide Calipers.												
7.2	Marking	Marking is able to be read easily.	Visual Inspection.												
7.3	Capacitance and Tolerance	Meet item 3.	<table border="1"> <thead> <tr> <th colspan="3">Table 2</th> </tr> <tr> <th>Frequency</th> <th>Test Voltage</th> <th>Capacitance</th> </tr> </thead> <tbody> <tr> <td>1 ± 0.1MHz</td> <td>1 ± 0.2Vrms</td> <td>22pF ~ 150pF</td> </tr> <tr> <td>1 ± 0.1kHz</td> <td>1 ± 0.2Vrms</td> <td>220pF ~ 100000pF</td> </tr> </tbody> </table>	Table 2			Frequency	Test Voltage	Capacitance	1 ± 0.1MHz	1 ± 0.2Vrms	22pF ~ 150pF	1 ± 0.1kHz	1 ± 0.2Vrms	220pF ~ 100000pF
Table 2															
Frequency	Test Voltage	Capacitance													
1 ± 0.1MHz	1 ± 0.2Vrms	22pF ~ 150pF													
1 ± 0.1kHz	1 ± 0.2Vrms	220pF ~ 100000pF													
7.4	Insulation Resistance(I.R.)	Meet item 3.	Test Voltage : Rated Voltage Time : 1 minute through a suitable resistor 1MΩ.												

No.	Item	Specification	Test Method												
7.5	Withstanding Voltage	Products shall not be damaged.	Test Voltage : 2.5 times for Rated Voltage Time : 1 to 5 seconds Charge Current : 10 mA max. It shall be applied between input / output terminal and ground terminal.												
7.6	Temperature Characteristics	Meet item 3.	Capacitance shall be measured at each step specified in Table 3 after reaching the thermal equilibrium. The capacitance change against the capacitance at step 3 shall be calculated. <u>Table3</u> <table border="1" style="margin-left: 20px; border-collapse: collapse; text-align: center;"> <tr> <td style="width: 5%;">Step</td> <td style="width: 10%;">1</td> <td style="width: 10%;">2</td> <td style="width: 10%;">3</td> <td style="width: 10%;">4</td> <td style="width: 10%;">5</td> </tr> <tr> <td>Temp. (°C)</td> <td>+20±2</td> <td>-40±2</td> <td>+20±2</td> <td>+85±2</td> <td>+20±2</td> </tr> </table>	Step	1	2	3	4	5	Temp. (°C)	+20±2	-40±2	+20±2	+85±2	+20±2
Step	1	2	3	4	5										
Temp. (°C)	+20±2	-40±2	+20±2	+85±2	+20±2										

8. Q200 Requirement

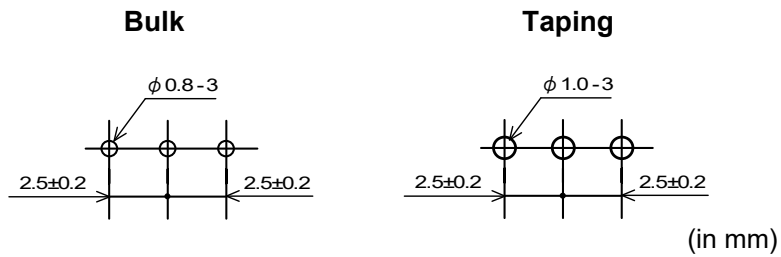
8-1. Performance (based on Table 13 for Ferrite EMI SUPPRESSORS/FILTERS)

AEC-Q200 Rev.D issued June. 1 2010

AEC-Q200			Murata Specification / Deviation						
No.	Stress	Test Method							
3	High Temperature Exposure (Storage)	1000hours at 85C Set for 24hours at room temperature, then measured. Measurement at 24+/-2 hours after test conclusion.	Meet Table 4 after testing. <u>Table 4</u> <table border="1" style="margin-left: 20px; border-collapse: collapse; text-align: center;"> <tr> <td style="width: 50%;">Appearance</td> <td>No damaged.</td> </tr> <tr> <td>Capacitance Change</td> <td>within ± 30%</td> </tr> <tr> <td>Insulation Resistance</td> <td>10MΩ min.</td> </tr> </table>	Appearance	No damaged.	Capacitance Change	within ± 30%	Insulation Resistance	10MΩ min.
Appearance	No damaged.								
Capacitance Change	within ± 30%								
Insulation Resistance	10MΩ min.								
4	Temperature Cycling	1000cycles(-40C to 85C) Measurement at 24±2 hours after test conclusion.	Meet Table 4 after testing.						
5	Destructive Physical Analysis	Per EIA469 No electrical tests	Not Applicable						
7	Biased Humidity	1000hours 85C/85%RH. Apply Maximum rated Voltage. Measurement at 24+/-2 hours after test conclusion.	Meet Table 4 after testing.						
8	Operational Life	1000hours at 85C Apply Maximum rated Voltage. Measurement at 24+/-2 hours after test conclusion.	Meet Table 4 after testing.						
9	External Visual	Visual inspection	No abnormalities						
10	Physical Dimension	Meet ITEM 10.1 (Style and Dimensions)	No defects						
11	Terminal Strength (Leaded)	Per MIL-STD-202 Method 211 Conditions:A,C	Condition E: Not Applicable Lead wire should not cut off. Capacitor should not be broken.						
12	Resistance to Solvents	Per MIL-STD-202 Method 215	Not Applicable						
13	Mechanical Shock	Per MIL-STD-202 Method 213 Figure 1 of Method 213. Condition C(100g's/6ms/Half sine) Three times each 6 direction.	Meet Table 4 after testing.						
14	Vibration	5g's for 20 minutes, 12cycles each of 3 orientations Oscillation Frequency : 10-2000Hz.	Meet Table 4 after testing.						

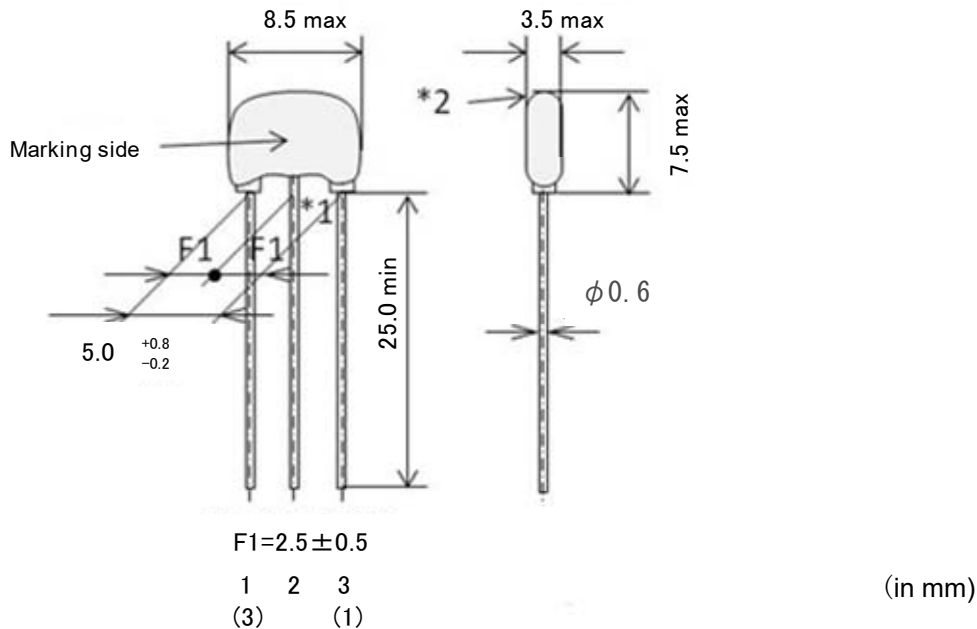
AEC-Q200			Murata Specification / Deviation
No.	Stress	Test Method	
15	Resistance to Soldering Heat	No heating. 260C +/-5 degree C Immersion time 10s	Meet Table 4 after testing.
17	ESD	Per AEC-Q200-002	Meet Table 4 after testing. ESD Rank: Refer to Item 3. Rating.
18	Solderability	Per J-STD-002 Method A	Along the circumference of terminal shall be covered with new solder at least 75%.
19	Electrical Characterization	Measured :Capacitance	No defects
20	Flammability	Per UL-94	Not Applicable
21	Board Flex	Per AEC Q200-005	Not Applicable
30	Electrical Transient Conduction	Per ISO-7637-2	Not Applicable

9. Mounting Hole



10. Style and Dimension

10.1 Bulk(Straight Lead Type) : Q55B

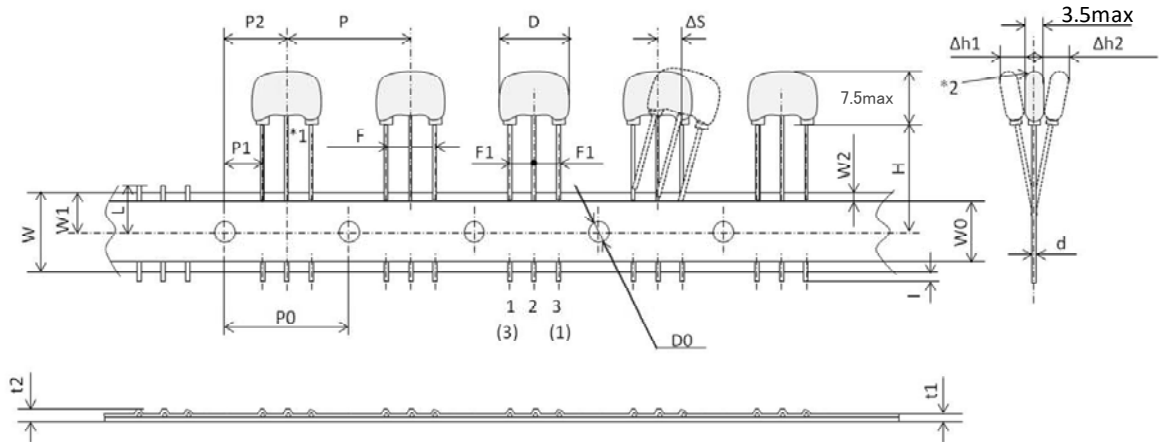


*1. Bottom of dielectric may be exposed.

*2. There should not be the exposure of the ferrite bead if a hole is on the top of ferrite bead.

10.2 Taping(Straight Lead Type) : Q9□A

(All symbols in the illustrations below are described in Table 4)



*1.Bottom of dielectric may be exposed.

*2.There should not be the exposure of the ferrite bead if a hole is on the top of ferrite bead.

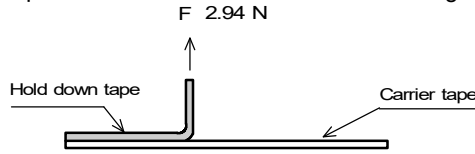
Table 4

Code	Description	Dimensions	Remark
P	Pitch of Component	12.7	Product Inclination ΔS Determines Crossing
P0	Pitch of Sprocket Hole	12.7±0.2	
P1	Length from Hole Center to Lead	3.85±0.7	
P2	Length from Hole Center to Component Center	6.35±1.3	
D	Width of Body	8.5 max.	
ΔS	Deviation along tape, Left or Right	0±1.0	
W	Carrier Tape Width	18.0±0.5	
W1	Position of Sprocket Hole	9.0 +0,-0.5	Tape Widthwise Shift
l	Protrusion Length	+0.5 ~ -1.0	
D0	Diameter of Sprocket Hole	φ 4.0±0.1	
d	Lead Diameter	φ 0.6	
t1	Total Tape Thickness	0.7±0.2	Includes Thickness of Bonding Tape
t2	Total Thickness, Tape and Lead Wire	1.5 max.	
Δh1	Deviation across Tape, front	1.0 max.	
Δh2	Deviation across Tape, rear	1.0 max.	
L	Portion to Cut in Case of Defect	11.0 +0,-1.0	
W0	Hold Down Tape Width	12.0±0.5	
W2	Hold Down Tape Position	1.5±1.5	
H	Lead length between sprocket hole and forming position	Q91	20.0±1.0
		Q92	16.5±1.0
		Q93	18.5±1.0
F	Lead Spacing	5.0 +0.8,-0.2	
F1		2.5 +0.4,-0.2	

(in mm)

11. Taping

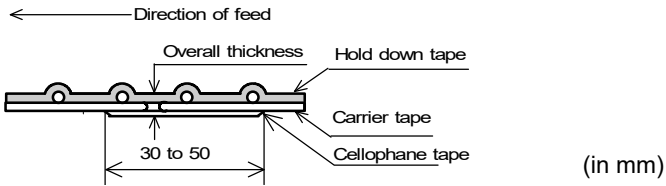
- (1) A maximum of 0.3% of the components quantity per Ammo pack may be missing without consecutive missing components.
- (2) The adhesive power of the tape shall have over 2.94N at the following condition.



(3) Splicing method of tape

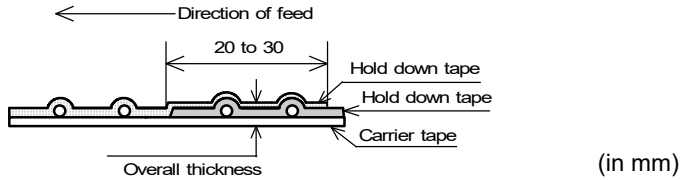
1. Carrier tape

Carrier tape shall be spliced by cellophane tape.
Overall thickness shall be less than 1.05 mm.



2. Hold down tape

Hold down tape shall be spliced with overlapping.
Overall thickness shall be less than 1.05 mm.



3. Both carrier tape and hold down tape

Both tapes shall be cut zigzag and spliced with splicing tape.

12. Packing

12.1 Packing quantity

The standard packing quantity is as follows.

(The packing quantity may be changed due to a fraction of order.)

Minimum Packing Form and Quantity

Terminal Configuration	A Unit Quantity	Packing Form	* Standard Quantity in a container (corrugated cardboard box)
Bulk	250 pcs.	In a plastic bag	5000pcs.
Taping	1500 pcs.	In an Ammo pack	7500pcs.

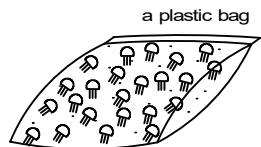
* A quantity in a container is depending on a quantity of an order.

12.2 Packing Form

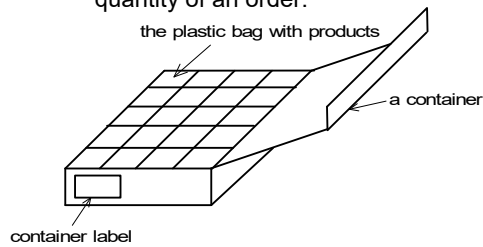
(1) Bulk

<A plastic bag pack>

1. Products are packed into a plastic bag.



2. The plastic bags are put into a container (corrugated cardboard box) depending on a quantity of an order.

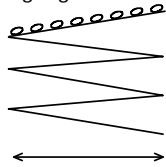


(2) Taping

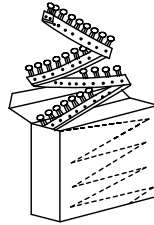
<An ammo pack>

1. Folding the tape per 25 pitches, products are packed into an ammo package so that each product of each layer wound zigzag is put on top of one another. [Fig 3]
2. The dimensions of the ammo package are indicated in [Fig 4].
3. The ammo packages are put into a container (corrugated cardboard box) depending on a quantity of an order.
4. Not less than 3 consecutive of component shall be missing on both edge of tape.

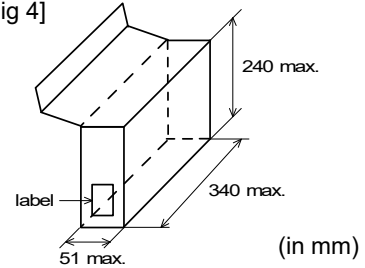
[Fig 3] zig zag



The unloading direction : Right
 The hold down tape : Upper
 The product body : Left along the unloading direction



[Fig 4]



13. Marking on package

13.1 Unit Package

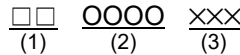
Bulk : Marked on a plastic bag.

Taping : Marked on a label stuck on an ammo package.

Marking on a unit package consists of :

Customer part number, MURATA part number, Inspection number(*1), RoHS marking (*2), Quantity, etc

*1) « Expression of Inspection No. »



(1) Factory Code

(2) Date

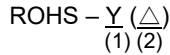
First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep. → 1 to 9, Oct. to Dec. → O,N,D

Third, Fourth digit : Day

(3) Serial No.

*2) « Expression of RoHS marking »



(1) RoHS regulation conformity parts.

(2) MURATA classification number

13.2 Container

Marking on the label stuck on a container consists of :

Customer name Purchasing Order Number, Customer Part Number, MURATA part number, RoHS marking (*2), Quantity, etc

14. ⚠ Caution

14.1 Mounting holes

Mounting holes should be designed as specified in this specifications.

Or different design from this specifications may cause cracks in ceramics which may lead to smoking / firing.

14.2 Caution for the product angle adjust work

Take care not to apply any mechanical stress to product body at the lead terminal bending process for product angle adjustment after insertion.

14.3 Limitation of Applications

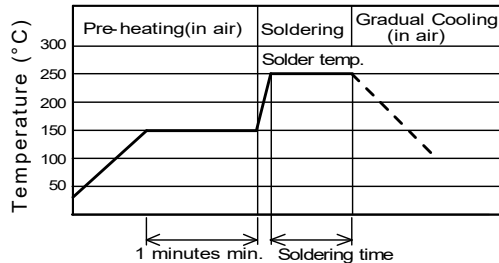
Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- | | |
|--|--|
| (1) Aircraft equipment | (7) Traffic signal equipment |
| (2) Aerospace equipment | (7) Disaster prevention / crime prevention equipment |
| (3) Undersea equipment | (9) Data-processing equipment |
| (4) Power plant control equipment | (10) Applications of similar complexity and /or reliability requirements |
| (5) Medical equipment | to the applications listed in the above |
| (6) Transportation equipment (trains, ships, etc.) | |

15. Notice**15.1 Soldering**

- (1) Use rosin-based flux. Do not use strong acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value).
Use Sn-3.0Ag-0.5Cu solder

- (2) Standard flow soldering profile.



Solder temperature	Soldering time
250~260 °C	4~6s

- (3) Resistance to soldering iron goes in the following condition that tip temperature is 350 °C max. And soldering time is 5 s max.
(4) Products and the leads should not be subjected to any mechanical stress during soldering process. (and also while subjected to the equivalent high temperature.)

15.2 Cleaning

Products shall be cleaned on following conditions.

- (1) Cleaning Temperature: 60°C max.(40°C max. for Isopropyl alcohol).
(2) Ultrasonic cleaning shall comply with the following conditions, avoiding the resonance phenomenon at the mounted products and P.C.B.
Power : 20W / l max.
Frequency : 28kHz ~ 40kHz
Time : 5 minutes max.
(3) Cleaning agent
1. alcohol cleaning agents.
• Isopropyl alcohol (IPA)
2. Aqueous cleaning agent
• Pine Alpha ST-100S
(4) Ensure that residual flux and residual cleaning agent is completely removed.
Products should be thoroughly dried after aqueous agent has been removed with de-ionized water.
(5) For other cleaning methods, please contact Murata engineering.

15.3 Operating Environment

- (1) Do not use products in corrosive gases such as chlorine gas, acid or sulfide gas.
(2) Do not use products in the environment where water, oil or organic solvents may adhere to products.
(3) Do not adhere any resin to products, coat nor mold products with any resin (including adhesive) to prevent mechanical and chemical stress on products.

15.4 Storage and handling requirements.

- (1) Storage period
Use the products within 12 months after delivered.
Solderability should be checked if this period is exceeded.
(2) Storage environment condition
To prevent products quality deterioration, stored conditions should be controlled as follows ;
1. Temperature : -10 to 40 degrees centigrade
2. Humidity : 15 to 85% relative humidity
3. Products should be stored without sudden changes in temperature and humidity.
Don't keep products in corrosive gases such as sulfur, chlorine gas or acid,
or it may cause oxidization of lead terminals resulting in poor solderability.
4. Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
5. Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
(3) Handling Conditions
Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

16.  Note

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.